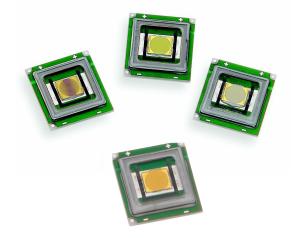


# SBT-70 LEDs



### **Features:**

- Extremely high optical output from a 7 mm<sup>2</sup> circular emitter:
  - Up to 2,000 white lumens
  - Over 880 red Lumens
  - Over 1,900 green lumens
  - Over 425 blue lumens
- Round emitting aperture provides most efficient match to circular optical systems and narrow beam projectors
- Unencapsulated die with low profile protective window optimizes optical coupling in etendue-limited applications
- High thermal conductivity package junction to case thermal resistance of only 0.7  $^{\circ}\text{C/W}$
- Variable drive current: 1 A to 10.5 A
- High CRI at tungsten white and daylight white color temperatures for natural lighting
- Environmentally friendly: RoHS compliant

### **Applications**

- Architectural and Entertainment
   Lighting
- Fiber-coupled Illumination
- Medical Lighting

- Machine Vision
- Microscopy
- Spot Lighting

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### **Technology Overview**

Luminus Big Chip LEDs<sup>™</sup> benefit from a suite of innovations in the fields of LED die technology, packaging and thermal management. These breakthroughs allow illumination engineers and designers to achieve solutions that are high brightness and high efficiency.

#### Luminus Technology

Luminus' technology enables large area LED chips with uniform brightness over the entire LED chip surface. The optical power and brightness produced by these large monolithic chips enable solutions which replace arc and halogen lamps where arrays of traditional high power LEDs cannot.

#### **Packaging Technology**

Thermal management is critical in high power LED applications. With a thermal resistance from junction to case of 0.7° C/W, Luminus SBT-70 LEDs have the lowest thermal resistance of any LED on the market. This allows the LED to be driven at higher current densities while maintaining a low junction temperature, thereby resulting in brighter solutions and longer lifetimes.

### Reliability

Designed from the ground up, Luminus Big Chip LEDs are one of the most reliable light sources in the world today. Big Chip LEDs have passed a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity, and have been fully qualified for use in extreme high power and high current applications. With very low failure rates and median lifetimes that typically exceed 60,000 hours, Luminus Big Chip LEDs are ready for even the most demanding applications.

### **Environmental Benefits**

Luminus LEDs help reduce power consumption and the amount of hazardous waste entering the environment. All Big Chip LED products manufactured by Luminus are RoHS compliant and free of hazardous materials, including lead and mercury.

### **Understanding Big Chip LED Test Specifications**

Every Luminus LED is fully tested to ensure that it meets the high quality standards expected from Luminus' products.

#### **Testing Temperature**

Luminus surface mount LEDs are typically tested with a 20 msec input pulse and a junction temperature of 25°C. Expected flux values in real world operation can be extrapolated based on the information contained within this product data sheet.

### Multiple Operating Points (7.0 A, 10.5 A)

The tables on the following pages provide typical optical and electrical characteristics. Since the LEDs can be operated over a wide range of drive conditions (currents from 1A to 10.5 A, and duty cycle from <1% to 100%), multiple drive conditions are listed.

SBT-70 White LEDs are production tested at 10.5 A. The values shown at other current conditions are for additional reference at other possible drive conditions.



### **SBT-70 White Binning Structure** $(T_i = 25 \circ C)$

.....

SBT-70 white LEDs are tested for luminous flux and chromaticity at a drive current of 10.5 A (1.5 A/mm<sup>2</sup>) and placed into one of the following luminous flux (FF) and chromaticity (WW) bins:

-

Flux Bins						
Color	Flux Bin (FF)	Minimum Flux (lm) at 10.5A	Maximum Flux (lm) at 10.5A			
	NB	1,710	1,830			
WCS Cool White Standard CRI (typ. 75)	PA	1,830	1,965			
cool white standard Chi (typ. 75)	Hux Bin (FF)         at 10.5A           NB         1,710           PA         1,830           PB         1,655           KA         1,040           KB         1,120           LA         1,200           HB         840           JA         900	1,655	2,100			
	КА	1,040	1,120			
WDH Daylight White High CRI (typ. 92)	КВ	1,120	1,200			
Daylight White High Chi (typ. 52)	LA	1,200	1,290			
WTH Tungsten White High CRI (typ. 92)	HB	840	900			
	JA	900	970			
	JB	970	1,040			

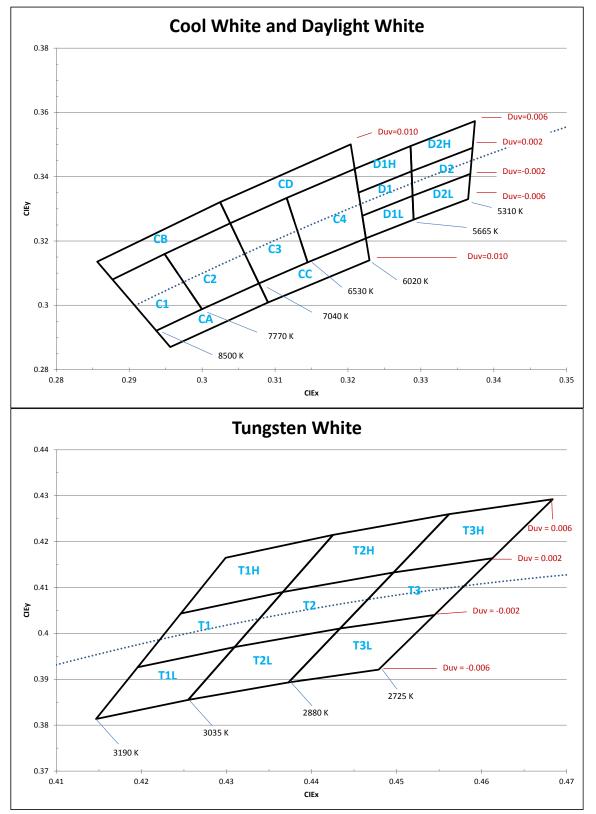
\*Note: Luminus maintains a +/- 6% tolerance on flux measurements.

Luminus maintains a +/- 2 tolerance on CRI measurements.



### **Chromaticity Bins**

Chromaticity Bins: 1931 CIE Curve





### SBT-70 White Chromaticity Bins

The following tables describe the four chromaticity points that bound each chromaticity bin. Chromaticity bins are grouped together based on the color temperature.

Cool White Chromaticity Bins					
Bin Code(WW)	CIEx	CIEy			
	0.293	0.292			
C1	0.299	0.298			
CI	0.294	0.315			
	0.287	0.307			
	0.299	0.298			
62	0.307	0.306			
C2	0.303	0.325			
	0.294	0.315			
	0.307	0.306			
C3	0.314	0.313			
	0.311	0.333			
	0.303	0.325			
	0.314	0.313			
C4	0.322	0.32			
C4	0.32	0.342			
	0.311	0.333			

Cool White Chromaticity Bins					
Bin Code(WW)	CIEx	CIEy			
	0.293	0.292			
СА	0.295	0.287			
	0.309	0.300			
	0.307	0.306			
	0.287	0.307			
СВ	0.285	0.313			
CB	0.302	0.332			
	0.303	0.325			
	0.307	0.306			
сс	0.309	0.300			
	0.322	0.313			
	0.322	0.320			
	0.303	0.325			
CD	0.302	0.332			
CD	0.320	0.350			
	0.320	0.342			



### SBT-70 White Chromaticity Bins

The following tables describe the four chromaticity points that bound each chromaticity bin. Chromaticity bins are grouped together based on the color temperature.

Daylight Chromaticity Bins					
Bin Code(WW)	CIEx	CIEy			
	0.321	0.327			
D1	0.321	0.335			
	0.328	0.341			
	0.328	0.334			
	0.328	0.334			
D2	0.328	0.341			
DZ	0.337	0.348			
	0.336	0.340			
	0.321	0.335			
D1U	0.320	0.342			
D1H	0.328	0.349			
	0.328	0.341			
	0.328	0.341			
Dall	0.328	0.349			
D2H	0.337	0.357			
	0.337	0.348			
	0.321	0.327			
	0.322	0.320			
D1L	0.328	0.326			
	0.328	0.334			
	0.328	0.334			
D2L	0.328	0.326			
DZL	0.336	0.333			
	0.336	0.340			

Tungsten White Chromaticity Bins					
Bin Code(WW)	CIEx	CIEy			
τ1	0.419	0.392			
	0.424	0.404			
T1	0.436	0.409			
	0.430	0.397			
	0.430	0.397			
тэ	0.436	0.409			
T2	0.449	0.413			
	0.443	0.401			
	0.443	0.401			
Т3	0.449	0.413			
15	0.461	0.416			
	0.454	0.404			
	0.424	0.404			
T1H	0.429	0.416			
110	0.442	0.421			
	0.436	0.409			
	0.436	0.409			
T2H	0.442	0.421			
1211	0.456	0.425			
	0.449	0.413			
	0.449	0.413			
ТЗН	0.456	0.425			
1311	0.468	0.429			
	0.461	0.416			
	0.419	0.392			
T1L	0.414	0.381			
116	0.425	0.385			
	0.430	0.397			
	0.430	0.397			
T2L	0.425	0.385			
126	0.437	0.389			
	0.443	0.401			
	0.443	0.401			
T3L	0.437	0.389			
132	0.447	0.392			
	0.454	0.404			



# SBT-70 R, G, B Binning Structure (T<sub>j</sub>= 25°C)

SBT-70 monochromatic LEDs are tested for luminous flux and dominant wavelength at a 10.5 A (1.5 A/mm<sup>2</sup>) drive current and placed into one of the following flux and wavelength bins. The binning structure is universally applied across each monochromatic color.

Color	Luminous Flux Bin (FF)	Minimum Flux	Maximum Flux		
Dad	BK	600	770		
Red	BM	770	970		
Green	CJ	1200	1500		
	СК	1500	2000		
	DJ	250	350		
Blue	DK	350	450		

#### Flux Bins (measured at 10.5A drive current)

\*Note: Luminus maintains a +/- 6% tolerance on flux measurements.

#### **Wavelength Bins**

Color	Wavelength Bin (FF)	Minimum Wavelength @ 10.5A	Maximum Wavelength @ 10.5A
	R3	615	619
Red	R4	619	623
	R5	623	627
	G4	520	525
Green	G5	525	530
Green	G6	530	535
	G7	535	540
	B4	450	455
Plus	B5	455	460
Blue	B6	460	465
	B7	465	470



### **Product Shipping & Labeling Information**

All SBT-70 products are packaged and labeled with their respective bin as outlined in the tables and charts on pages 3 - 7. When shipped, each package will only contain one bin. The part number designation is as follows:

SBT-70 White						
SBT –	- 70 -	— WNX —	— F75 —	– FF –	— ww	
Product Family	Chip Area	Color	Package Configuration	Flux Bin	Chromaticity Bin	
Surface Mount (window)	7.0 mm <sup>2</sup>	Color & CRI See Note 1 below	Internal Code	See page 3 for bins	See page 4 for bins	

Note 1: WNX nomenclature corresponds to the following:

W = White

N = color, where: C corresponds to Cool White, D corresponds to Daylight, and T corresponds to Tungsten White; R corresponds to red, G corresponds to green and B corresponds to blue.

*X* = color rendering index, where:

S (Standard) corresponds to a typical CRI of 75

H (high) corresponds to a typical CRI of 92

#### Example 1:

The part label SBT-70-WDH-F75-LA-D2 refers to a Daylight high CRI white, SBT-70 emitter, with a flux range from 1,200 to 1,290 lumens and a chromaticity value within the box defined by the four points (0.328. 0.334), (0.328, 0.341), (0.337, 0.348), (0.336, 0.340).

SBT-70-R, G, B						
SBT –	- 70 -	— N –	— F75 —	– FF –	– WW	
Product Family	Chip Area	Color	Package Configuration	Flux Bin	Wavlength Bin	
Surface Mount (window)	7.0 mm <sup>2</sup>	R: Red G: Green B: Blue	Internal Code	See page 7 for bins	See page 7 for bins	

#### Example:

The part number SBT-70-R-F75-BK-R4 refers to a red, SBT-70 surface mount, with a flux range of 600 - 770 lumens and a wavelength range of 619 nm to 623 nm.

Note: Some flux and wavelength bins may have limited availability. Application specific bin kits, consisting of multiple bins, may be available. For ordering information, please refer to page 20 and reference the PDS-002041: SBT-70 Binning & Labeling document.



### SBT-70 White Electrical Characteristics<sup>1</sup>

#### **Optical and Electrical Characteristics (T<sub>i</sub>= 25°C)**

Drive Condition <sup>2</sup>		7.0 A	10.5 A	
Parameter	Symbol	Typical Values at Indicated Current <sup>3</sup>	Values at Test Currents	Unit
Current Density	j	1.0	1.5	A/mm <sup>2</sup>
	V <sub>F, min</sub>		3.5	V
Forward Voltage	V <sub>F, typ</sub>	3.3	3.7	V
	V <sub>F, max</sub>		4.5	V

#### **Common Characteristics**

Parameter		Symbol	Typical Values	Unit
Emitting Area			7.0	mm²
Cool White		CRI	75	
Color Rendering Index (Typical)	Daylight White	CRI	92	
macx (Typical)	Tungsten White	CRI	92	
Forward Voltage Temperature Coefficient <sup>4</sup>			-2.45	mV/ºC

#### **Absolute Maximum Ratings**

Parameter	Symbol	Values	Unit
Maximum Current⁵		10.5	А
Maximum Junction Temperature <sup>6</sup>	T <sub>j-max</sub>	150	°C
Storage Temperature Range		-40/+100	°C

Note 1: All ratings are based on operation at room temperature.

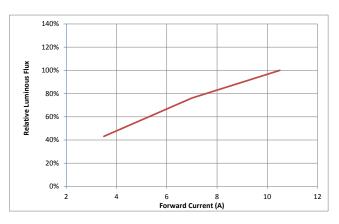
- Note 2: Listed drive conditions are typical for common applications. SBT-70 white devices can be driven at currents ranging from 1A to 10.5A and at duty cycles ranging from 1% to 100%. Drive current and duty cycle should be adjusted as necessary to maintain the junction temperature desired to meet application lifetime requirements.
- Note 3: Unless otherwise noted, values listed are typical.
- Note 4: CCT value based off of CIE measurement. CIE measurement uncertainty for white devices is estimated to be +/-0.01.
- Note 5: Forward voltage temperature coefficient at current density of 1.5 A/mm<sup>2</sup>. Contact Luminus for value at other drive conditions.
- Note 6: SBT-70 White LEDs are designed for operation to an absolute maximum forward drive current density of 1.5 A/mm<sup>2</sup>. Product lifetime data is specified at recommended forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to recommended forward drive currents. Actual device lifetimes will also depend on junction temperature. Refer to the lifetime derating curves for further information. In pulsed operation, rise time from 10-90% of forward current should be larger than 0.5 microseconds.
- Note 7: Lifetime dependent on LED junction temperature. Input power and thermal system must be properly managed to ensure lifetime. See charts on pg 10 for further information.
- Note 8: Special design considerations must be observed for operation under 1 A. Please contact Luminus for further information.
- Note 9: Caution must be taken not to stare at the light emitted from these LEDs. Under special circumstances, the high intensity could damage the eye.



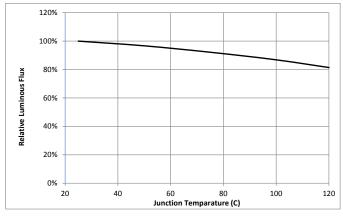
### SBT-70 Product Datasheet (Preliminary)

### SBT-70 White Optical & Electrical Characteristics

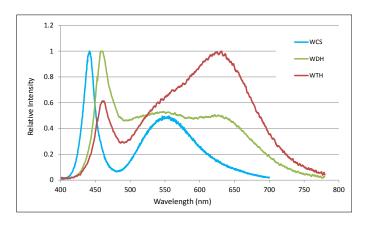
**Relative Output Flux vs. Forward Current** 



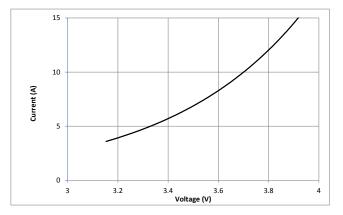
### **Relative Output Flux vs. Junction Temp**



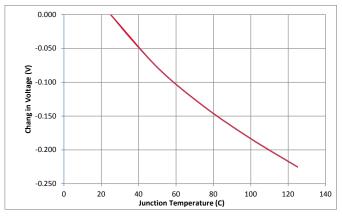




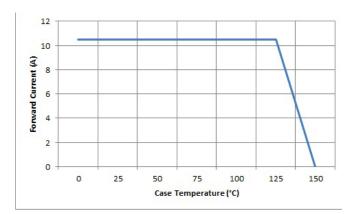
### Forward Current vs. Forward Voltage



### Change in Voltage vs. Junction Temp



#### **Current Derating Curve**



Note 1: Typical spectrum at current density of 1.5 A/mm<sup>2</sup> in continuous operation.



**Median Lifetime**<sup>2</sup>

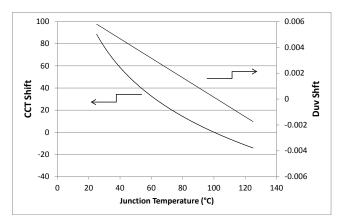
## SBT-70 Product Datasheet

### (Preliminary)

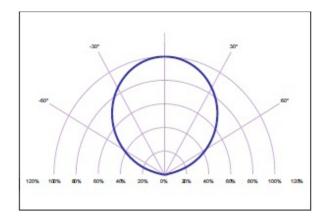
### SBT-70 White Optical & Electrical Characteristics

160 Device Junction Temperature (°C) 140 120 100 80 60 40 20 0 0 10,000 20,000 30,000 40,000 50,000 60,000 Median Lifetime Projection (Hours)

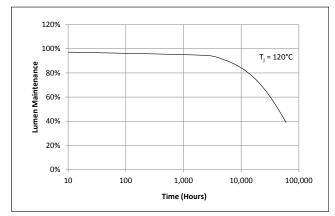
#### Chromaticity Change vs. Junction Temp (WTH)



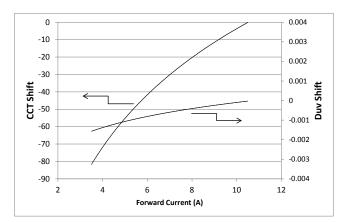
#### **Typical Polar Radiation Pattern**



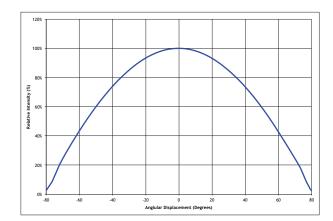
#### Lumen Maintenance vs. Time<sup>3</sup>



#### **Chromaticity Change vs. Forward Current (WTH)**



#### **Typical Angular Radiation Pattern**



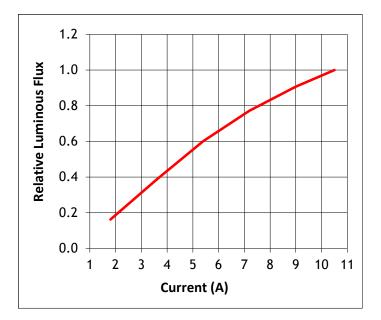
- Note 2: Mean expected lifetime in dependence of junction temperature at 1.5 A/mm<sup>2</sup> in continuous operation. Lifetime defined as time to 70% of initial intensity. Based on lifetime test data. Data can be used to model failure rate over typical product lifetime (contact Luminus for lifetime reliability test data for 1A/mm<sup>2</sup> condition).
- Note 3: Lumen maintenance in dependence of time at 1.5 A/mm<sup>2</sup> in continuous operation with junction temperatures of 130 °C.



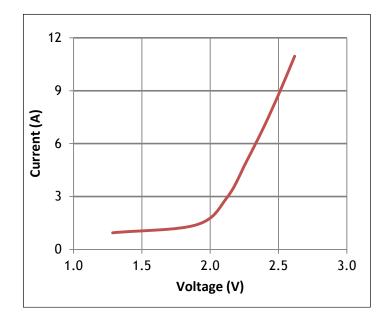
### SBT-70-R, G, B Optical & Electrical Characteristics

Red				
Drive Condition <sup>2</sup>		10.5A		
Parameter	Symbol	Values <sup>3</sup>	Unit	
Current Density	j	1.5	A/mm <sup>2</sup>	
	V <sub>F min</sub>	2.5	V	
Forward Voltage	V <sub>F</sub>	2.7	V	
	V <sub>F max</sub>	3.0	V	
Luminous Flux <sup>4</sup>	Φ <sub>V typ</sub>	860	lm	
Dominant Wavelength⁵	λ <sub>d</sub>	620	nm	
FWHM	$\Delta \lambda_{1/2}$	18	nm	
	Х	0.695	-	
Chromaticity Coordinates <sup>6,7</sup>	У	0.305	-	

### **Relative Output Flux vs. Forward Current<sup>1</sup>**



### Forward Current vs. Forward Voltage



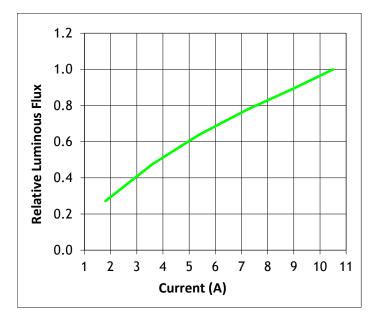
Note: For notes see page 15.



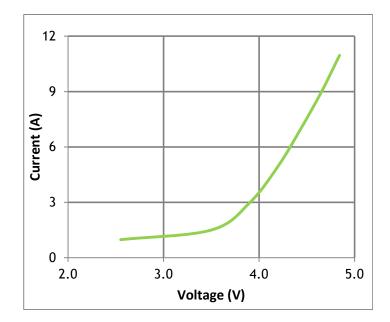
### SBT-70 R, G, B, Optical & Electrical Characteristics

Green				
Drive Condition <sup>2</sup>		10.5 A		
Parameter	Symbol	Values <sup>3</sup>	Unit	
Current Density	j	1.5	A/mm <sup>2</sup>	
	V <sub>F min</sub>	4.5	V	
Forward Voltage	V <sub>F</sub>	4.9	V	
	V <sub>F max</sub>	5.3	V	
Luminous Flux⁴	Φ <sub>V typ</sub>	1890	lm	
Dominant Wavelength⁵	$\lambda_{d}$	530	nm	
FWHM	$\Delta \lambda_{1/2}$	32	nm	
	х	0.205	-	
Chromaticity Coordinates <sup>6,7</sup>	у	0.740	-	

### **Relative Output Flux vs. Forward Current<sup>1</sup>**



### Forward Current vs. Forward Voltage



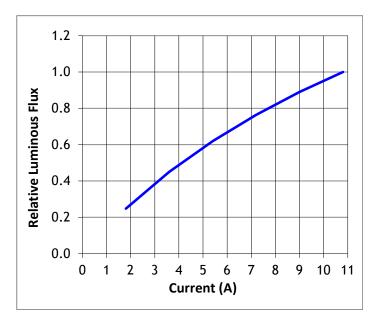
Note: For notes see page 15.



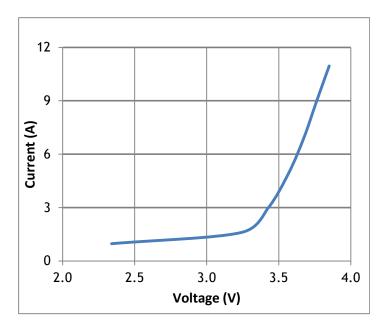
### SBT-70 R, G, B, Optical & Electrical Characteristics

Blue				
Drive Condition <sup>2</sup>		10.5 A		
Parameter	Symbol	Values <sup>3</sup>	Unit	
Current Density	j	1.5	A/mm <sup>2</sup>	
	V <sub>F min</sub>	3.2	V	
Forward Voltage	V <sub>F</sub>	3.8	V	
	V <sub>F max</sub>	4.2	V	
Luminous Flux <sup>4</sup>	$\Phi_{_{V  typ}}$	410	lm	
Dominant Wavelength⁵	$\lambda_{d}$	461	nm	
FWHM	$\Delta\lambda_{1/2}$	19	nm	
Chucuraticity Coordinates67	Х	0.142	0.142	
Chromaticity Coordinates <sup>6,7</sup>	У	0.036	0.038	

### **Relative Output Flux vs. Forward Current<sup>1</sup>**



### Forward Current vs. Forward Voltage



Note: For notes see page 15.



### SBT-70, R, G, B, Optical & Electrical Characteristics Notes

- Note 1: All ratings are based on a junction test temperature  $Tj = 25^{\circ}C$ . See Thermal Resistance section for Tj definition.
- Note 2: Listed drive conditions are typical for common applications. Big Chip LED SBT-70 RGB devices can be driven at currents ranging from <1 A to 10.5 A and at duty cycles ranging from 1% to 100%. Drive current and duty cycle should be adjusted as necessary to maintain the junction temperature desired to meet application lifetime requirements.
- Note 3: Unless otherwise noted, values listed are typical. Devices are production tested and specified at 10.5A. Other values are for reference only.
- Note 4: Total flux from emitting area at listed dominant wavelength. Reported performance is included to show trends for a selected power level. For specific minimum and maximum values, use bin tables. For product roadmap and future performance of devices, contact Luminus.
- Note 5: Minimum and Maximum Dominant Wavelengths are based on typical values +/- 5nm for Red, +/- 8nm for Green and +/- 6nm for Blue.
- Note 6: In CIE 1931 chromaticity diagram coordinates, normalized to X+Y+Z=1.
- Note 7: For reference only.

Common Characteristics					
	Symbol	Red	Green	Blue	Unit
Emitting Area		7.0	7.0	7.0	mm <sup>2</sup>
Emitting Area (Diameter)		3	3	3	mm
Dynamic Resistance	$\Omega_{_{ m dyn}}$	0.03	0.04	0.02	Ω
Thermal Coefficient of Photometric Flux		-0.96	-0.18	-0.007	%/ °C
Thermal Coefficient of Radiometric Flux		-0.52	-0.20	-0.17	%/ °C
Thermal Coefficient of Junction Voltage		-1.3	-4.6	-3.5	mV/ °C

#### SBT-70-R, G, B

#### Absolute Maximum Ratings

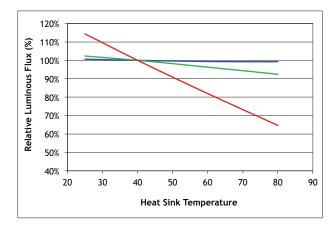
	Symbol	Red	Green	Blue	Unit
Maximum Current <sup>8</sup>		10.5	10.5	10.5	A
Maximum Junction Temperature <sup>9</sup>	T <sub>jmax</sub>	100	150	150	°C
Storage Temperature Range		-40/+100	-40/+100	-40/+100	°C

Note 8: Luminus Big Chip LEDs are designed for operation to an absolute maximum current as specified above. Product lifetime data is specified at recommended forward drive currents. Sustained operation at or beyond absolute maximum currents will result in a reduction of device life ime compared to recommended forward drive currents. Actual device lifetimes will also depend on junction temperature. Refer to the lifetime derating curves for further information. In pulsed operation, rise time from 10-90% of forward current should be larger than 0.5 microseconds.

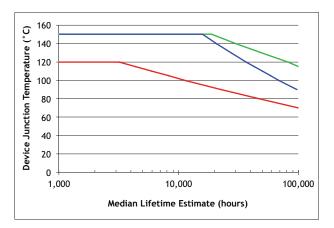
Note 9: Lifetime dependent on LED junction temperature. Input power and thermal system must be properly managed to ensure lifetime. See charts on pg 16 for further information.

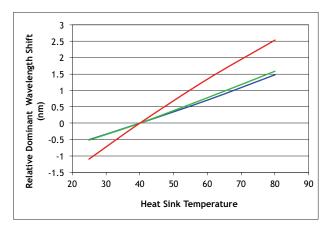


### SBT-70-R, G, B, Output vs. Temp., Lifetime and Spectrum

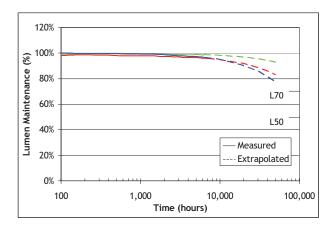


### Median Lifetime Estimate vs. Tj<sup>1</sup>

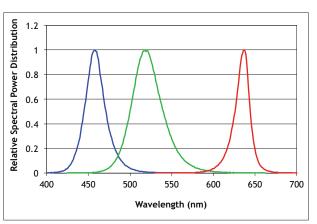




### Lumen Maintenance<sup>2</sup>



### **Typical Spectrum<sup>3</sup>**

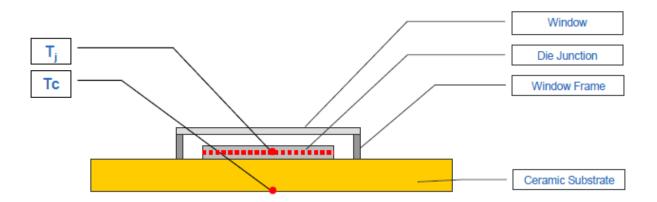


- Note 1. Median lifetime estimate as a function of junction temperature at 1.5A/mm<sup>2</sup> in continuous operation. Lifetime defined as time to 70% of initial intensity. Based on preliminary lifetime test data. Data can be used to model failure rate over typical product lifetime.
- Note 2. Lumen maintenance vs. time at 1.5A/mm2 in continuous operation, junction temperature equal to 25°C.
- Note 3. Typical spectrum at current density of 1.5 A/mm<sup>2</sup> in continuous operation.



### **Thermal Resistance**

**Thermal Resistance Model** 



#### **Typical Thermal Resistance**

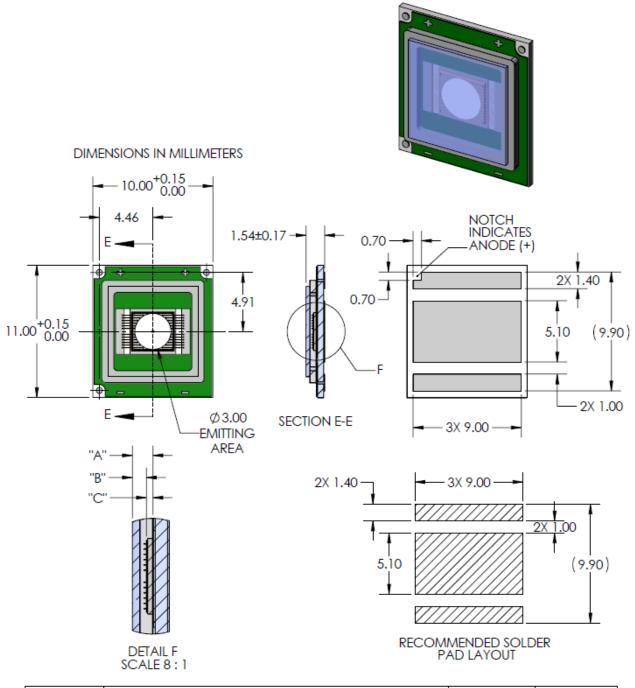
R <sub>j-c</sub> <sup>1</sup>	0.7 °C/W
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Note 1:  $R_{j,c}$  is the thermal resistance from the junction  $T_i$  to the ceramic substrate,  $T_c$ 

Note 1: Thermal resistance values are preliminary based on modeled results.



### **Mechanical Dimensions – SBT-70 Emitter**

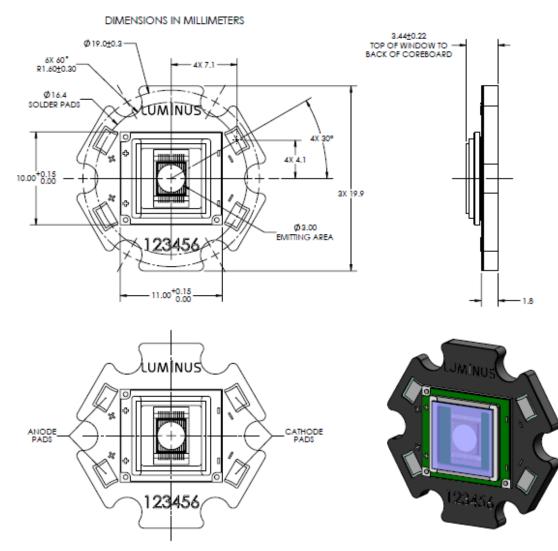


DIMENSION NAME	DESCRIPTION	NOMINAL DIMENSION	TOLERANCE
"A"	TOP OF CERAMIC SUBSTRATE TO TOP OF GLASS	.86	±0.10
"B"	TOP OF EMITTING AREA TO TOP OF GLASS	.58	±0.14
"C"	TOP OF CERAMIC SUBSTRATE TO TOP OF EMITTING AREA	.28	<u>+0.03</u>

DWG-002087



### Mechanical Dimensions – SBT-70 Star Board



DWG-002153

- Note 1: Tolerances per IPC-610, Class 2
- Note 2: For detail drawing of SBT-90, please see DWG 002087
- Note 3: Recommended mounting screw: M3 or #4
- Note 4: All dimensions in millimeters

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Note 5: All anode pads on board are interconnected. All cathode pads on board are interconnected



### **Ordering Information**

Ordering Part Number 1,2,3,4	Color	Description
SBT-70-WCS-F75-PA120	Cool White	
SBT-70-WDH-F75-LA220	Daylight White	White Big Chip LED <sup>™</sup> SBT-70 consisting of a 7 mm² LED on a ceramic substrate
SBT-70-WTH-F75-HB720	Tungsten White	
SBT-70-R-F75-HG100	Red	Red Big Chip LED <sup>™</sup> SBT-70 consisting of a 7 mm <sup>2</sup> LED on a ceramic substrate
SBT-70-G-F75-JF200	Green	Green Big Chip LED <sup>™</sup> SBT-70 consisting of a 7 mm <sup>2</sup> LED on a ceramic substrate
SBT-70-B-F75-KE300	Blue	Blue Big Chip LED <sup>™</sup> SBT-70 consisting of a 7 mm <sup>2</sup> LED on a ceramic substrate
SBR-70-WCS-R75-PA120	Cool White	
SBR-70-WDH-R75-LA220	Daylight White	White SBT-70 surface mount device mounted on an aluminum star board
SBR-70-WTH-R75-HB720	Tungsten White	
SBR-70-R-R75-HG100	Red	Red SBT-70 surface mount device mounted on an aluminum star board
SBR-70-G-R75-JF200	Green	Green SBT-70 surface mount device mounted on an aluminum star board
SBR-70-B-R75-KE300	Blue	Blue SBT-70 surface mount device mounted on an aluminum star board

Note 1: PA120 - denotes a bin kit comprising of all flux bins with a minimum flux of 1,830 lumens and chromaticity bins at cool white color point.

Note 2: LA220 - denotes a bin kit comprising of all flux bins with a minimum flux of 1,200 lumens and chromaticity bins at daylight white color point.

Note 3: HB720 - denotes a bin kit comprising of all flux bins with a minimum flux of 780 lumens and chromaticity bins at tungsten white color point.

Note 4: Standard packaging increment (SPI) is 25.

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